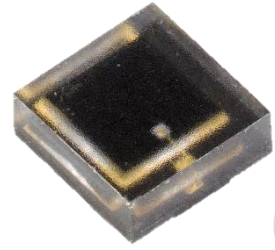


# SA2020P03CV00 Datasheet



Broadband Silicon PIN Photodiode



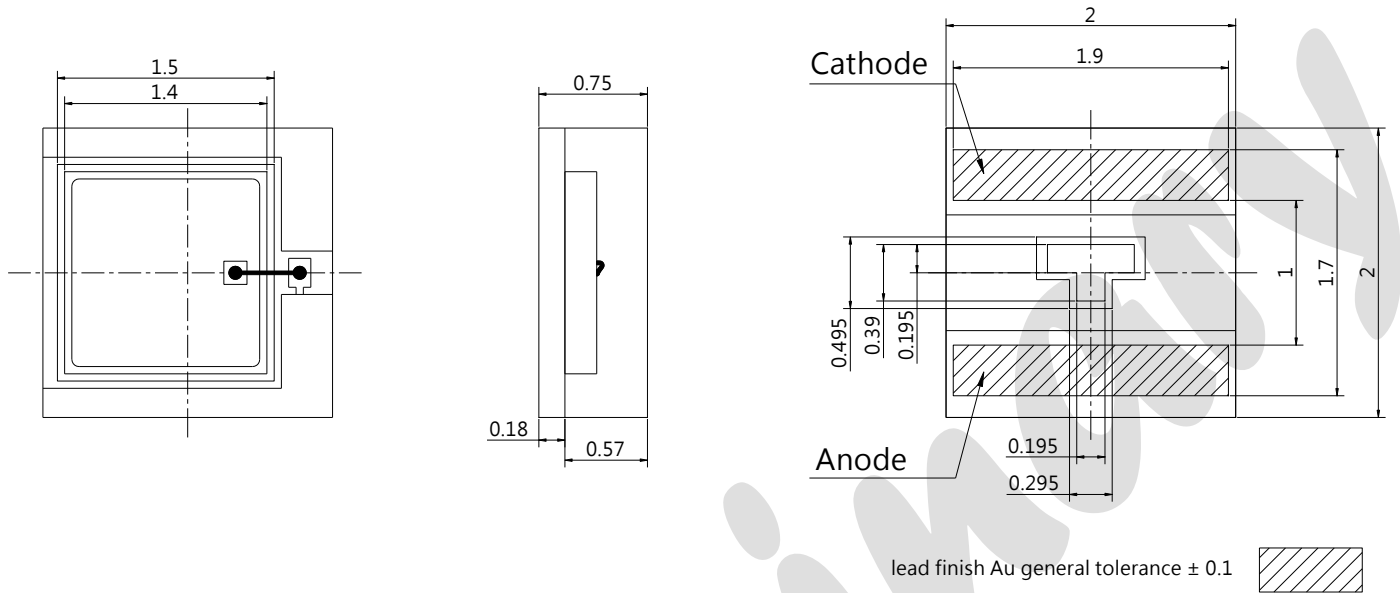
## Applications

- Health Monitoring (Heart Rate Monitoring, Pulse Oximetry)

## Features

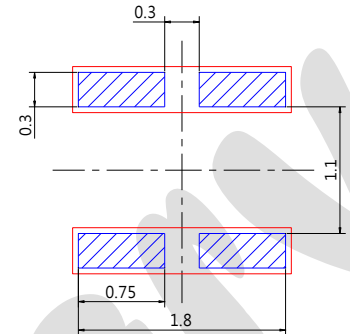
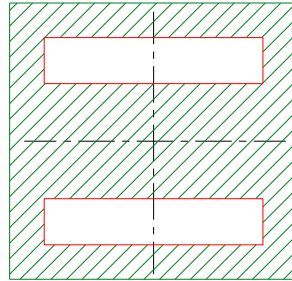
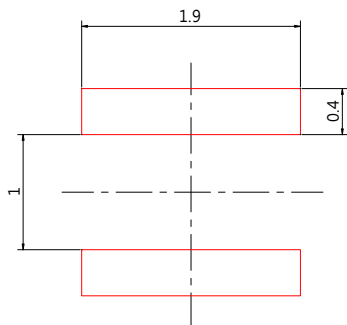
- Package: clear epoxy
- ESD: 2KV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)
- Suitable for reflow soldering
- Especially suitable for applications from 400 nm to 1100 nm
- Small package (L x W x H) : 2.0 mm x 2.0 mm x 0.75 mm (W x D x H)

## Dimensional Drawing




1. Dimensions are in millimeters.
2. General tolerance is  $\pm 0.1$  mm.

## Recommended Solder Pad

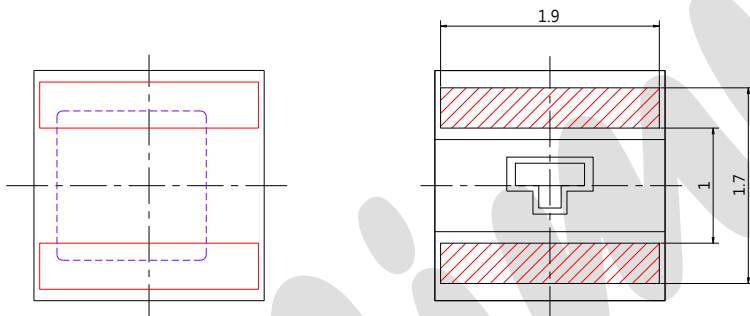


 foot print

 Solder resist

 Solder stencil recommended stencil thickness 120 um

Component Location on Pad



## Maximum Ratings

T<sub>A</sub> : 25 °C

Parameter	Symbol	Values
Operating temperature	T <sub>op</sub>	Min. - 40 °C
		Max. 85 °C
Storage temperature	T <sub>stg</sub>	Min. - 40 °C
		Max. 85 °C
Reverse voltage	V <sub>R</sub>	Max. 6 V
ESD withstand voltage acc. to ANSI/ESDA/JEDC JS-001 (HBM, Class 2)	V <sub>ESD</sub>	Max. 2 kV

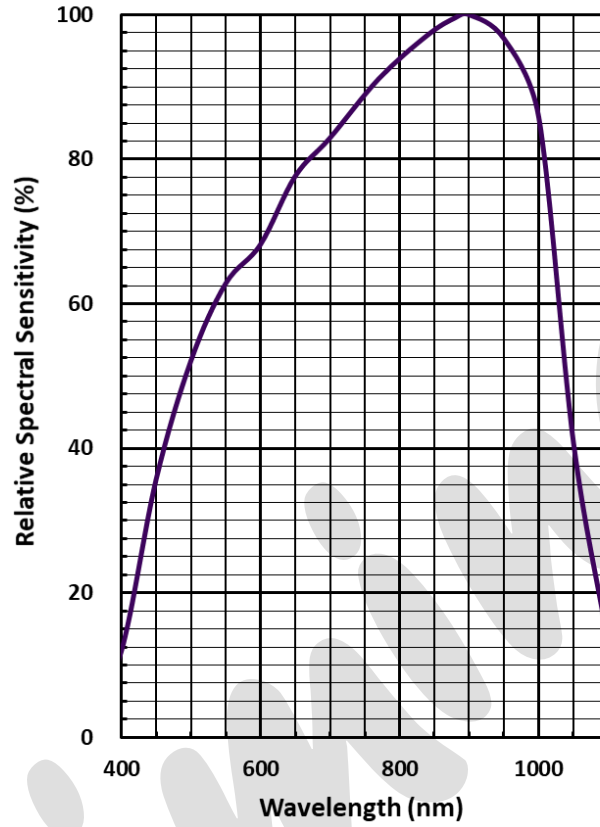
## Characteristics

T<sub>A</sub> : 25 °C

Parameter	Symbol		Values
Wavelength of max sensitivity	$\lambda_{S \max}$	Typ.	900 nm
Spectral range of sensitivity	$\lambda_{10\%}$	Typ.	400 ... 1100 nm
Photocurrent E <sub>e</sub> = 0.1 mW/cm <sup>2</sup> ; $\lambda$ = 530 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	0.69 $\mu$ A
Photocurrent E <sub>e</sub> = 1 mW/cm <sup>2</sup> ; $\lambda$ = 530 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	6.79 $\mu$ A
Photocurrent E <sub>e</sub> = 0.1 mW/cm <sup>2</sup> ; $\lambda$ = 660 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	0.96 $\mu$ A
Photocurrent E <sub>e</sub> = 1 mW/cm <sup>2</sup> ; $\lambda$ = 660 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	9.73 $\mu$ A
Photocurrent E <sub>e</sub> = 0.1 mW/cm <sup>2</sup> ; $\lambda$ = 940 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	1.19 $\mu$ A
Photocurrent E <sub>e</sub> = 1 mW/cm <sup>2</sup> ; $\lambda$ = 940 nm; V <sub>R</sub> = 5 V	I <sub>P</sub>	Typ.	12.08 $\mu$ A
Radiant sensitive area	A	Typ.	1.49 mm <sup>2</sup>
Dimensions of active chip area	L x W	Typ.	1.22 x 1.22 mm x mm
Half angle	$\varphi$	Typ.	60 °
Dark current V <sub>R</sub> = 5 V	I <sub>R</sub>	Typ. Max.	0.17 nA 25 nA
Rise time V <sub>R</sub> = 5 V; R <sub>L</sub> = 50 $\Omega$ ; $\lambda$ = 530 nm; I <sub>p</sub> = 600 $\mu$ A	t <sub>r</sub>	Typ.	47 ns
Fall time V <sub>R</sub> = 5 V; R <sub>L</sub> = 50 $\Omega$ ; $\lambda$ = 530 nm; I <sub>p</sub> = 600 $\mu$ A	t <sub>f</sub>	Typ.	67 ns
Forward voltage I <sub>F</sub> = 10 mA; E = 0	V <sub>F</sub>	Typ.	0.89 V
Capacitance V <sub>R</sub> = 0 V; f = 1 MHz; E = 0	C	Typ.	13.4 pF

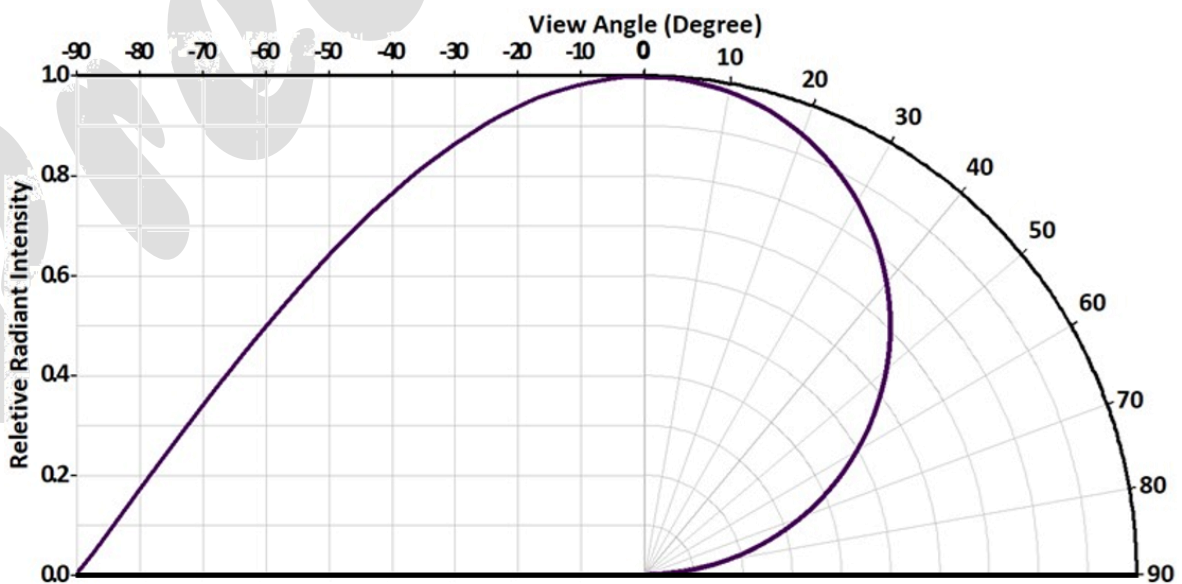
## Relative Spectral Sensitivity

$$S_{rel} = f(\lambda)$$



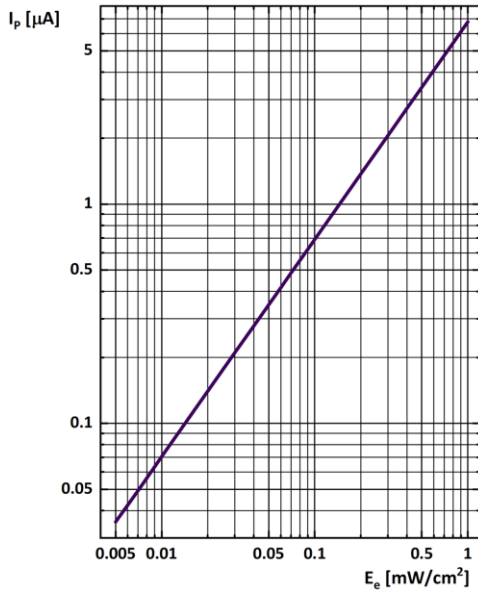
## Directional Characteristics

$$S_{rel} = f(\lambda)$$



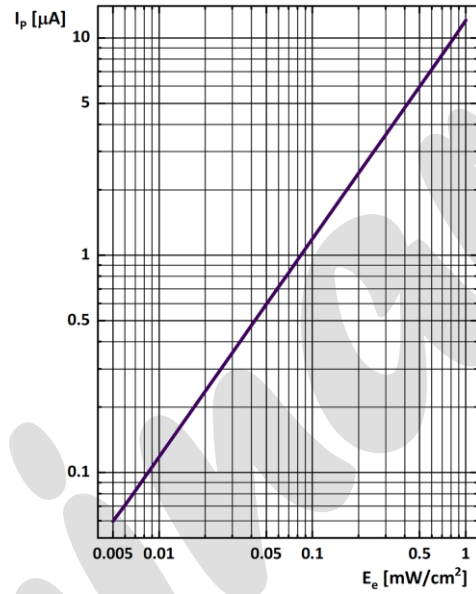
## Photocurrent

$$I_p = f(E_e); \lambda = 530 \text{ nm}; V_R = 5 \text{ V}$$



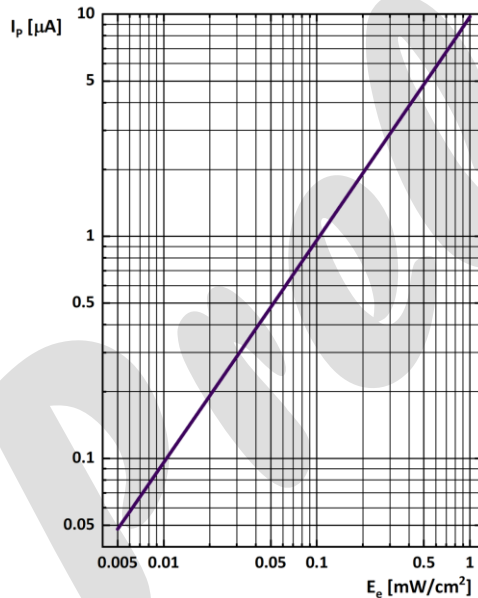
## Photocurrent

$$I_p = f(E_e); \lambda = 940 \text{ nm}; V_R = 5 \text{ V}$$



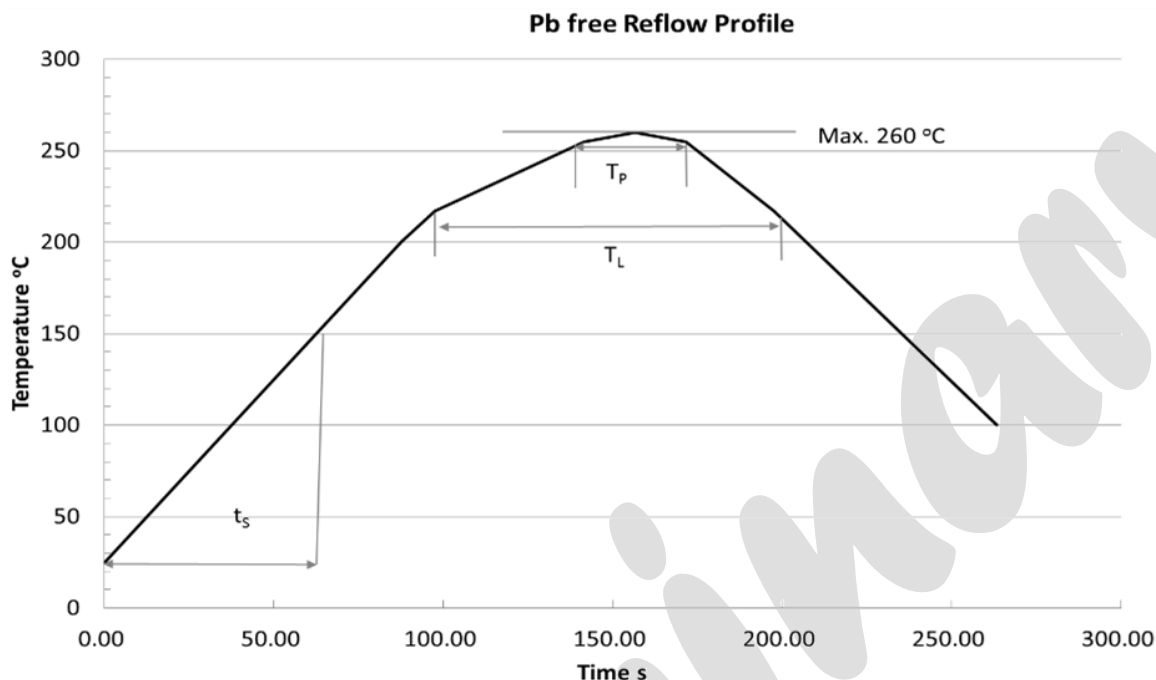
## Photocurrent

$$I_p = f(E_e); \lambda = 660 \text{ nm}; V_R = 5 \text{ V}$$



## Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak $T_{Smax}$ to $T_P$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_P$		245	260	°C
Time within 5 °C of the specified peak temperature $T_P$ - 5 K	$T_P$	10	20	30	s
Ramp-down Rate $T_P$ to 100 °C			3	4	K/s
Time 25 °C to $T_P$				480	s

1. Do not stress the silicone resin while it is exposed to high temperature.
2. The reflow process should not exceed 2 times.



## Disclaimer

1. Brightek reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets Brightek published specification for a period of one year from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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